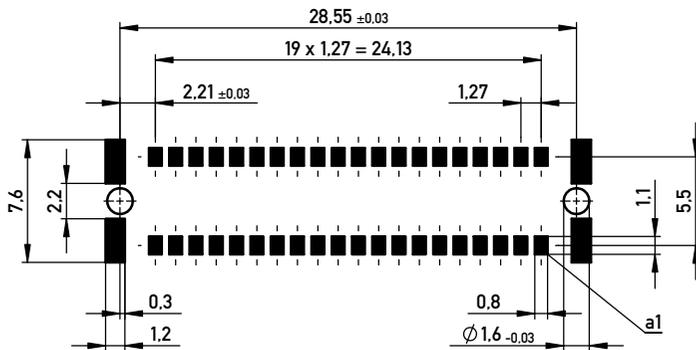


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



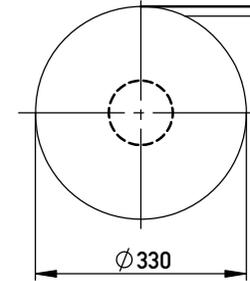
Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs

Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm



BA 8-03 - Standard Bauhöhe

type 8-03 - Standard Assembly Height

Information:		Tolerances	 All Dimensions in mm	Scale	3:1
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